



DUAL P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	Rds(on)	I _D T _A = +25°C
-30V	1000mΩ @VGS = -4.5V	-0.76A
-307	1500mΩ @Vgs = -2.5V	-0.62A

Description

This new generation MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

Applications

- Backlighting
- DC-DC converters
- · Power-management functions

Features and Benefits

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

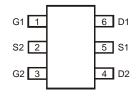
Mechanical Data

- Package: TSOT26
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
 - Terminals Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (§3)
- Weight: 0.013 grams (Approximate)

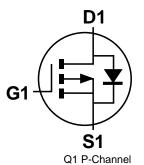
TSOT26

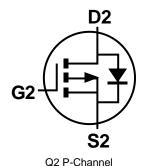


Top View



Top View





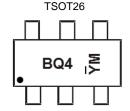
Ordering Information (Note 4)

Part Number	Paakaga	Packing		
Fait Number	Package	Qty.	Carrier	
DMP31D1UVT-7	TSOT26	3000	Tape & Reel	
DMP31D1UVT-13	TSOT26	10,000	Tape & Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



 $\frac{BQ4}{Y} = \text{Product Type Marking Code}$ $\frac{Y}{Y} = \text{Date Code Marking}$ $\frac{Y}{Y} = \text{Year (ex: K = 2023)}$ M = Month (ex: 8 = August)

Date Code Key

Year	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032	2033
Code	J	K	L	М	N	Р	R	S	T	U	V	W
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage			V _{DSS}	-30	V
Gate-Source Voltage			Vgss	±8	V
Continuous Drain Current (Note 6) Vgs = -4.5V	Steady State	$T_A = +25$ °C $T_A = +70$ °C	ID	-0.76 -0.61	А
Maximum Continuous Body Diode Forward Current (Note	Is	-0.72	Α		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I _{DM}	-1.9	Α

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	PD	0.5	W
Thermal Resistance, Junction to Ambient @T _A = +25°C (Note 5)	RθJA	243	°C/W
Power Dissipation (Note 6)	PD	0.9	W
Thermal Resistance, Junction to Ambient @T _A = +25°C (Note 6)	Reja	143	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

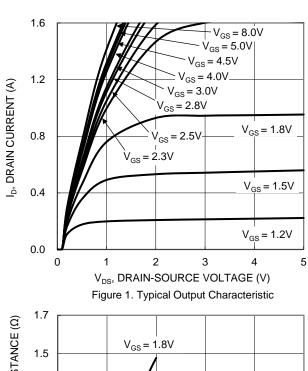
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	-30	_	_	V	$V_{GS} = 0V, I_{D} = -250\mu A$	
Zero Gate Voltage Drain Current	IDSS	_	_	-1	μΑ	$V_{DS} = -30V$, $V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}		_	±10	μΑ	$V_{GS} = \pm 8V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	-0.5	_	-1.1	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	
			0.7	1		$V_{GS} = -4.5V$, $I_{D} = -400mA$	
Static Drain-Source On-Resistance	RDS(ON)	_	0.85	1.5	Ω	$V_{GS} = -2.5V, I_{D} = -200mA$	
			1	2		$V_{GS} = -1.8V, I_{D} = -100mA$	
Diode Forward Voltage	VsD	_	-0.8	-1.2	V	$V_{GS} = 0V, I_{S} = -300mA$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	54	_		V 45V V 0V	
Output Capacitance	Coss	_	10.9	_	pF	$V_{DS} = -15V, V_{GS} = 0V,$ f = 1.0MHz	
Reverse Transfer Capacitance	Crss		5.8	_		1 = 1.01011 12	
Total Gate Charge (V _{GS} = -4.5V)	Qg	_	1.0	_		V _{GS} = -4.5V, V _{DS} = -15V, I _D = -1A	
Total Gate Charge (V _{GS} = -8V)	Qg	_	1.6	_	nC	\\ 0\\ \\ 45\\	
Gate-Source Charge	Qgs	_	0.2	_	lic	$V_{GS} = -8V, V_{DS} = -15V,$ $I_{D} = -1A$	
Gate-Drain Charge	Q_{gd}	_	0.1	_		ID = - IA	
Turn-On Delay Time	t _{D(ON)}	_	3.8	_	_		
Turn-On Rise Time	t _R	_	11	_	ns	$V_{DD} = -10V$, $R_L = 10\Omega$,	
Turn-Off Delay Time	t _{D(OFF)}	_	45	_	118	$V_{GS} = -4.5V$, $R_G = 6\Omega$	
Turn-Off Fall Time	tF	_	20				

Notes:

- Device mounted on FR-4 substrate PCB, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PCB, 2oz copper, with 1inch square copper plate.
 Repetitive rating, pulse width limited by junction temperature.
 Guaranteed by design. Not subject to production testing.





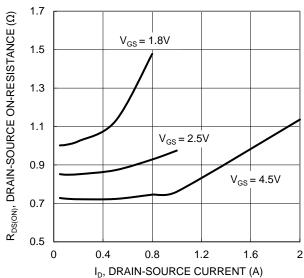


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

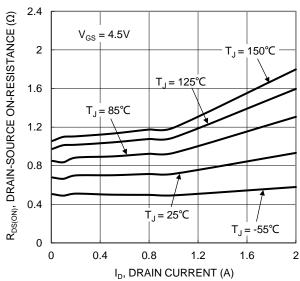


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature

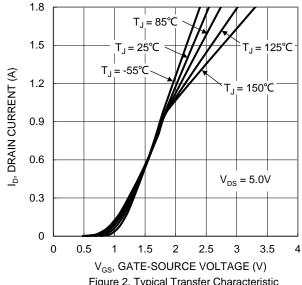


Figure 2. Typical Transfer Characteristic

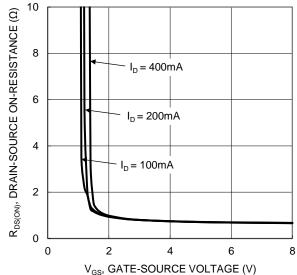


Figure 4. Typical Transfer Characteristic

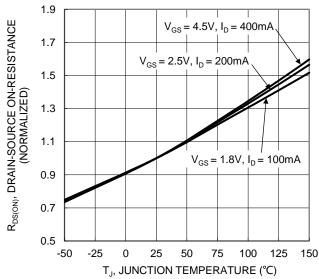


Figure 6. On-Resistance Variation with Junction **Temperature**



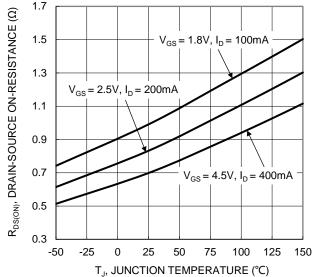


Figure 7. On-Resistance Variation with Junction Temperature

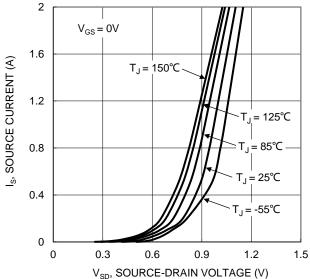


Figure 9. Diode Forward Voltage vs. Current

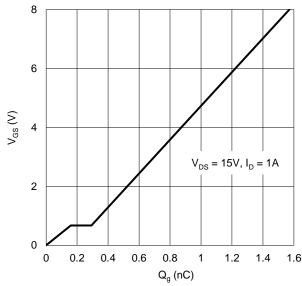


Figure 11. Gate Charge

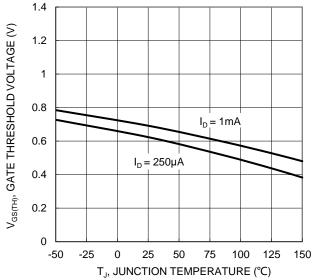


Figure 8. Gate Threshold Variation vs. Junction Temperature

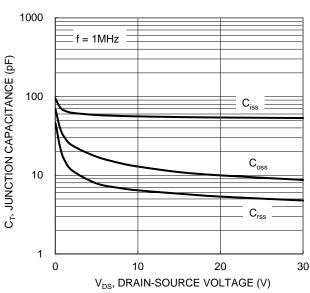


Figure 10. Typical Junction Capacitance

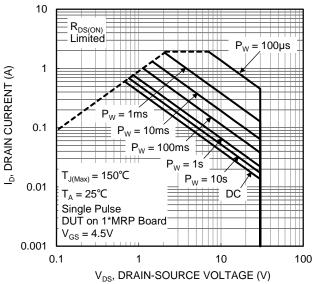


Figure 12. SOA, Safe Operation Area



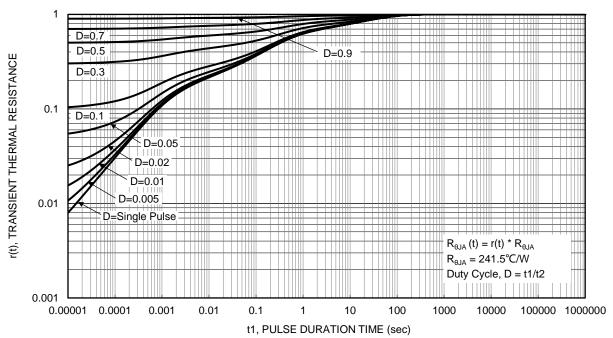


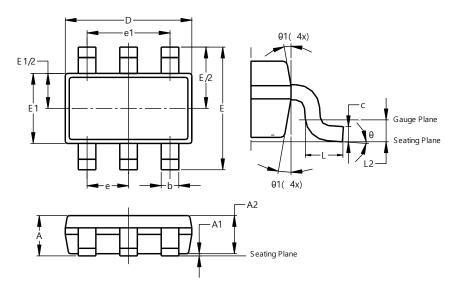
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

TSOT26

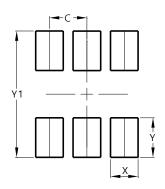


TSOT26							
Dim	Min	Max	Тур				
Α	-	1.00	-				
A1	0.010	0.100	-				
A2	0.840	0.900	-				
D	2.800	3.000	2.900				
Е	2	2.800 BSC					
E1	1.500	1.700	1.600				
b	0.300	0.450	-				
C	0.120	0.200	-				
е	0.950 BSC						
e1	1	.900 BS	Ċ				
_	0.30	0.50	_				
L2	0.250 BSC						
θ	0°	8°	4°				
θ1	4°	12°	-				
All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

TSOT26



Dimensions	Value (in mm)
С	0.950
Х	0.700
Y	1.000
Y1	3 200



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